

### **General Description**

The FDMS86181E use advanced SGT MOSFET

technology to provide low RDS(ON), low gate charge, fast switching and excellent avalanche characteristics.

This device is specially designed to get better ruggedness and suitable.

### **General Features**

V<sub>DS</sub> =100V I<sub>D</sub> =120A

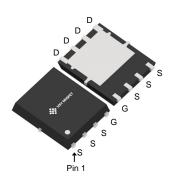
 $R_{DS(ON)}$  < 4.4m $\Omega$ @  $V_{GS}$ =10V

### **Applications**

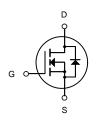
Consumer electronic power supply Motor control

Synchronous-rectification Isolated DC

Synchronous-rectification applications



DFN5X6-8L



N-Channel MOSFET

## **Package Marking and Ordering Information**

Product ID	Pack	Brand	Qty(PCS)
FDMS86181E	DFN5X6-8L	HXY MOSFET	5000

### Absolute Maximum Ratings (Tc =25°C unless otherwise noted)

Symbol	Parameter	Rating	Units
V <sub>D</sub> S	Drain-Source Voltage	V	
Vgs	Gate-Source Voltage	±20	V
In@Tc=25°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	120	А
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current, V <sub>GS</sub> @ 10V <sup>1</sup>	81	А
Ірм	Pulsed Drain Current <sup>2</sup>	512	А
EAS	Single Pulse Avalanche Energy <sup>3</sup>	486	mJ
las	Avalanche Current	67	А
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation <sup>4</sup>	176	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
Rejc	Thermal Resistance from Junction-to-Ambient <sup>3</sup>	0.8	°C/W
ReJA	Thermal Resistance Junction-Ambient <sup>1</sup>	56	°C/W



### Electrical Characteristics (T<sub>J</sub> = 25°C, unless otherwise noted)

Symbol	Parameter Conditions		Min.	Тур.	Max.	Unit	
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	100			V	
$\triangle BV_{DSS}/\triangle T_{J}$	BV <sub>DSS</sub> Temperature Coefficient	Reference to 25°C , I <sub>D</sub> =1mA				V/°C	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	V <sub>GS</sub> =10V , I <sub>D</sub> =20A		3.6	4.4		
	Static Drain-Source On-Resistance	V <sub>GS</sub> =4.5V , I <sub>D</sub> =20A				mΩ	
V <sub>GS(th)</sub>	Gate Threshold Voltage	\\ -\\   -250\	2.0	3.0	4.0	V	
$\triangle V_{GS(th)}$	V <sub>GS(th)</sub> Temperature Coefficient	$V_{GS}=V_{DS}$ , $I_D=250uA$				mV/°C	
I <sub>DSS</sub>	Drain Course Leakers Current	V <sub>DS</sub> =80V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1		
	Drain-Source Leakage Current	V <sub>DS</sub> =80V, V <sub>GS</sub> =0V , T <sub>J</sub> =100°C			100	uA	
I <sub>GSS</sub>	Gate-Source Leakage Current	$V_{GS} = \pm 20V$ , $V_{DS} = 0V$			±100	nA	
gfs	Forward Transconductance	V <sub>DS</sub> =5V , I <sub>D</sub> =20A		35		S	
$R_g$	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz		1.6		Ω	
Qg	Total Gate Charge			69			
Q <sub>gs</sub>	Gate-Source Charge	V <sub>DS</sub> =50V , V <sub>GS</sub> =10V , I <sub>D</sub> =20A		24		nC	
Q <sub>gd</sub>	Gate-Drain Charge			18.5			
T <sub>d(on)</sub>	Turn-On Delay Time			18.0			
T <sub>r</sub>	Rise Time	VGS=10V, VDD=50V,		23			
T <sub>d(off)</sub>	Turn-Off Delay Time	RG=3Ω, ID=20A		37		ns	
T <sub>f</sub>	Fall Time			15.7			
C <sub>iss</sub>	Input Capacitance			4102			
Coss	Output Capacitance	V <sub>DS</sub> =50V , V <sub>GS</sub> =0V , f=1MHz		592		pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			19.8			

#### **Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current <sup>1,5</sup>	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current			120	Α
V <sub>SD</sub>	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =1A , T <sub>J</sub> =25°C			1.2	V

#### Note:

FÈThe Ádata Ádested Áby Ásurface Ámounted Ábn Áa Ál Ánch<sup>2</sup> FR-4 Áboard Ávith Á2OZ Ásopper.

CÉTheÁdataÁestedÁbyÁpulsedÁþpulseÁvidthÁs 300usÁÁdutyÁsycleÁs 2%
HĚTheÁEASÁdataÁshowsÁMax.ÁratingÁÁTheÁestÁsonditionÁsÁTJ = 25°C, L = 3.0mH, IAS = 18A, VGS = 10V, VDD = 50V; 100% test at L = 0.1mH, IAS =

I À he Ápower Ádissipation Ás Áimited Áby Á 50°C junction Áemperature

Í 🖹 heÁdataÁsÁheoreticallyÁheÁsameÁssÁ<sub>DÆ</sub>andÁ<sub>DMÁ</sub>ÁnÁtealÁspplicationsÁÁshouldÁseÁimitedÁsyÁtotalÁsowerÁ dissipation.



### **Typical Characteristics**

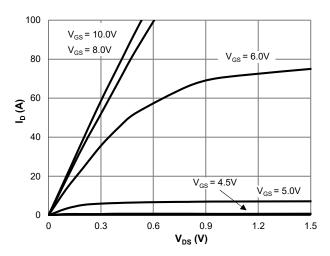


Figure 1: Saturation Characteristics

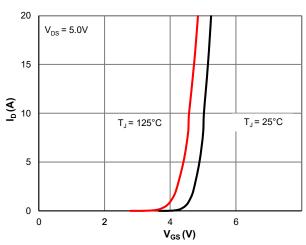


Figure 2: Transfer Characteristics

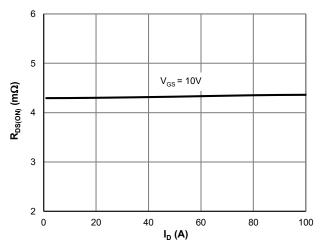


Figure 3:  $R_{DS(ON)}$  vs. Drain Current

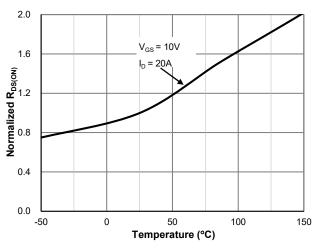


Figure 4: R<sub>DS(ON)</sub> vs. Junction Temperature

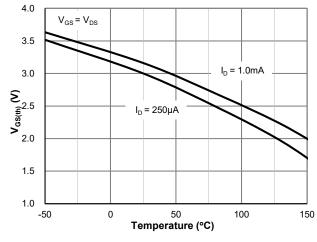


Figure 5:  $V_{GS(th)}$  vs. Junction Temperature

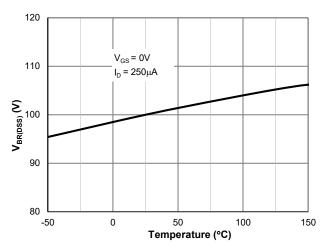
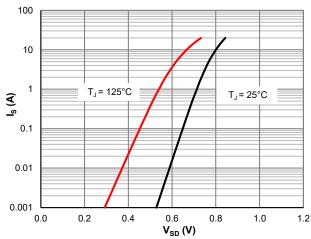


Figure 6:  $V_{BR(DSS)}$  vs. Junction Temperature







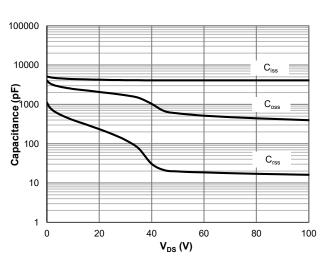


Figure 8: Capacitance Characteristics

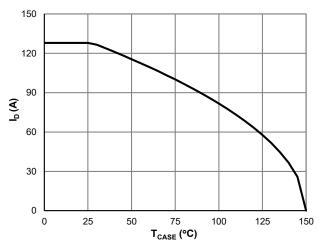


Figure 9: Current De-rating

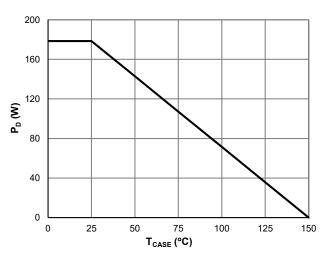


Figure 10: Power De-rating

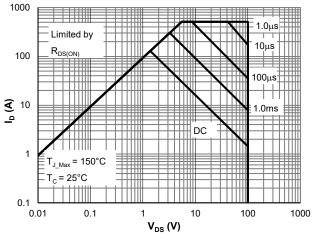


Figure 11: Maximum Safe Operating Area

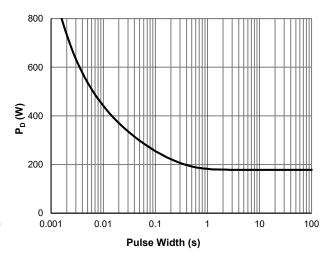


Figure 12: Single Pulse Power Rating, Junction-to-Case



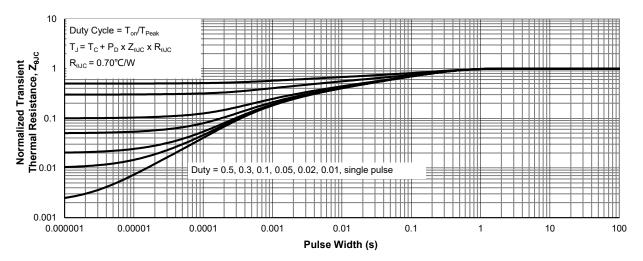
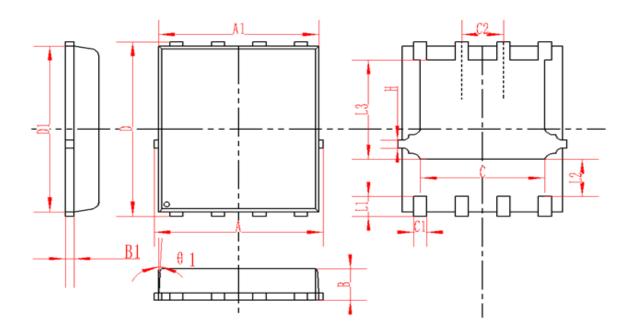


Figure 13: Normalized Maximum Transient Thermal Impedance



# **DFN5X6-8L Package Information**



SYMBOL	MM			INCH		
STIVIDOL	MIN	NOM	MAX	MIN	NOM	MAX
А	4.95	5	5.05	0.195	0.197	0.199
A1	4.82	4.9	4.98	0.190	0.193	0.196
D	5.98	6	6.02	0.235	0.236	0.237
D1	5.67	5.75	5.83	0.223	0.226	0.230
В	0.9	0.95	1	0.035	0.037	0.039
B1	0.254REF			0.010REF		
С	3.95	4	4.05	0.156	0.157	0.159
C1	0.35	0.4	0.45	0.014	0.016	0.018
C2	1.27TYP			0.5TYP		
θ1	8°	10°	12°	8°	10°	12°
L1	0.63	0.64	0.65	0.025	0.025	0.026
L2	1.2	1.3	1.4	0.047	0.051	0.055
L3	3.415	3.42	3.425	0.134	0.135	0.135
Η	0.24	0.25	0.26	0.009	0.010	0.010



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